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#71/Notice  
of  
PATENT  
Appeal  
10/9/02  
John H

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: : TSIU CHIU CHAN ET AL  
Serial No. : 09/160,824  
Filed : September 25, 1998  
For : STACKED MULTI-COMPONENT INTEGRATED  
CIRCUIT MICROPROCESSOR  
Group No. : 2826  
Examiner : T.L. Dickey

BOX AF  
Commissioner for Patents  
Washington, D. C. 20231

Sir:

NOTICE OF APPEAL

Applicant hereby appeals to the Board of Appeals from the decision dated May 3, 2002, of the Primary Examiner finally rejecting Claims 1-19.

A check in the amount of \$320.00 is enclosed in payment of the Notice of Appeal filing fee.

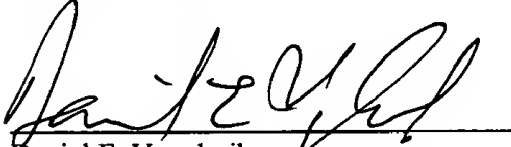
The Commissioner is hereby authorized to charge any additional fees connected with this communication or credit any overpayment to Davis Munck Deposit Account No. 50-0208.

09/13/2002 HBERHE 00000027 09160824  
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Respectfully submitted,

DAVIS MUNCK, P.C.



Daniel E. Venglarik  
Registration No. 39,409

Date: 7-3-02

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